HMC543ALC4B

# 22.5 MMIC 4-BIT DIGITAL PHASE SHIFTER, 8-12 GHz 

## Typical Applications

The HMC543LC4B is ideal for:

- EW Receivers
- Weather \& Military Radar
- Satellite Communications
- Beamforming Modules


## Functional Diagram



Features<br>Low RMS Phase Error: $4^{\circ}$<br>Low Insertion Loss: 6.5 dB<br>Excellent Flatness<br>$360^{\circ}$ Coverage, $\mathrm{LSB}=22.5^{\circ}$<br>24 Lead Ceramic SMT Package: $16 \mathrm{~mm}^{2}$

## General Description

The HMC543ALC4B is a 4-bit digital phase shifter which is rated from 8 to 12 GHz , providing 0 to 360 degrees of phase coverage, with a LSB of 22.5 degrees. The HMC543ALC4B features very low RMS phase error of 4 degrees and extremely low insertion loss variation of $\pm 0.8 \mathrm{~dB}$ across all phase states. This high accuracy phase shifter is controlled with complementary logic of $0 /-3 \mathrm{~V}$, and requires no fixed bias voltage. The HMC543ALC4B is housed in a compact $4 \times 4 \mathrm{~mm}$ ceramic leadless SMT package and is internally matched to 50 Ohms with no external components. Simple external level shifting circuitry can be used to convert a positive CMOS control voltage into complementary negative control signals.

Electrical Specifications, $T_{A}=+25^{\circ} \mathrm{C}, 50$ Ohm System, Control Voltage $=0 /-3 \mathrm{~V}$

| Parameter |  | Min. | Typ. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Frequency Range |  | 8 |  | 12 | GHz |
| Insertion Loss* | $\begin{gathered} 8.0-11.0 \mathrm{GHZ} \\ 11.0-12.0 \mathrm{GHZ} \end{gathered}$ |  | $\begin{aligned} & 6.5 \\ & 7.5 \end{aligned}$ | $\begin{gathered} 8 \\ 9.5 \end{gathered}$ | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Input Return Loss* | 8.0-12.0 GHZ |  | 10 |  | dB |
| Output Return Loss* | 8.0-12.0 GHZ |  | 10 |  | dB |
| Phase Error* | 8.0-12.0 GHZ |  | +5/-10 | $\pm 15$ | deg |
| RMS Phase Error | 8.0-12.0 GHZ |  | 4 |  | deg |
| Gain Variation* | $\begin{array}{r} 8.0-11.0 \mathrm{GHZ} \\ 11.0-12.0 \mathrm{GHZ} \end{array}$ |  | $\begin{aligned} & \pm 0.8 \\ & \pm 1.5 \end{aligned}$ |  | $\begin{aligned} & \mathrm{dB} \\ & \mathrm{~dB} \end{aligned}$ |
| Input Power for 1 dB Compression | 8.0-12.0 GHZ | 21 | 24.5 |  | dBm |
| Input Third Order Intercept | 8.0-12.0 GHZ |  | 40 |  | dBm |
| Control Voltage Current | 8.0-12.0 GHZ |  | 0.4 |  | $\mu \mathrm{A}$ |

*Note: All States Shown

Insertion Loss, All States


Input Return Loss, All States


Output Return Loss, All States


Normalized Loss, All States


Phase Error, All States


Relative Phase Shift, All States


Relative Phase Shift, RMS, Average, Max, All States


Input IP2, All States


RMS Phase Error vs. Temperature


Input IP3, All States


Input P1dB, All States


Insertion Loss $\mathbf{+ 2 5}{ }^{\circ} \mathrm{C}$, All States



Phase Error vs. State


Insertion Loss $-40^{\circ} \mathrm{C}$, All States


Absolute Maximum Ratings

| Input Power (RFin) (8-11 GHz) | $+27 \mathrm{dBm}\left(\mathrm{T}=+85^{\circ} \mathrm{C}\right)$ |
| :--- | :--- |
| Channel Temperature (Tc) | $150{ }^{\circ} \mathrm{C}$ |
| Thermal Resistance <br> (channel to ground paddle) | $130^{\circ} \mathrm{C} / \mathrm{W}$ |
| Storage Temperature | -65 to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature | -40 to $+85^{\circ} \mathrm{C}$ |
| ESD sensitivity(HBM) | Class 0 Passed 100 V |

Control Voltage

| State | Bias Condition |
| :---: | :---: |
| Low (0) | -2.5 to $-3.5 \mathrm{~V} @ 0.4 \mu \mathrm{~A}$ Typ. |
| High (1) | 0 to $+0.3 \mathrm{~V} @ 0.4 \mu \mathrm{~A}$ Typ. |

ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Truth Table

| Control Voltage Input |  |  |  |  |  |  |  | Phase Shift (Degree) RFIN - RFOUT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Bit 1 | $\overline{\text { Bit } 1}$ | Bit 2 | $\overline{\text { Bit } 2}$ | Bit 3 | $\overline{\text { Bit } 3}$ | Bit 4 | $\overline{\text { Bit } 4}$ |  |
| 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | Reference |
| 1 | 0 | 0 | 1 | 0 | 1 | 0 | 1 | 22.5 |
| 0 | 1 | 1 | 0 | 0 | 1 | 0 | 1 | 45.0 |
| 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 90.0 |
| 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | 180.0 |
| 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 337.5 |
| Any combination of the above states will provide a phase shift approximately equal to the sum of the bits selected. |  |  |  |  |  |  |  |  |

## Outline Drawing

## BOTTOM VIEW



NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM - -C-
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ${ }^{[2]}$ |
| :---: | :---: | :---: | :---: | :---: |
| HMC543ALC4B | Alumina, White | Gold over Nickel | MSL3 $^{[1]}$ | H543A <br> XXXX |

[^0]
## Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
| :---: | :---: | :---: | :---: |
| 1，2，17－24 | N／C | No connection required．These pins may be connected to RF／DC ground without affecting performance． |  |
| 3，5，14， 16 | GND | These pins and exposed ground paddle must be connected to RF／DC ground． | OGND |
| 4 | RFIN | This port is matched to 50 Ohms． | RFIN ${ }^{-}$ |
| 6，9，11， 13 | BIT3，BIT1， BIT2，BIT4 | Non－Inverted Control Input．See truth table and control voltage tables． |  |
| 7，8，10， 12 | $\begin{aligned} & \overline{\mathrm{BIT3} 3}, \overline{\mathrm{BIT} 1} \\ & \overline{\mathrm{BIT} 2}, \overline{\mathrm{BIT} 4} \end{aligned}$ | Inverted Control Input．See truth table and control voltage tables． |  |
| 15 | RFOUT | This port is matched to 50 Ohms． | $\longrightarrow$ ORFOUT |

## Application Circuit

This circuit converts a single line positive $(0 /+5 \mathrm{~V})$ control signal to complementary negative $(0 /-3 \mathrm{~V})$ control signals．


## Evaluation PCB



List of Materials for Evaluation PCB EV1HMC543ALC4B [1][3]

| Item | Description |
| :--- | :--- |
| J1- J2 | PCB Mount SMA RF Connector |
| J3- J4 | Molex Header 2mm |
| U1 | HMC543ALC4B 4-Bit Digital Phase Shifter |
| PCB [2] | 116253 Evaluation PCB |

[1] Reference this number when ordering complete evaluation PCB
[2] Circuit Board Material: Rogers 4350
[3] Please refer to part's pin description and functional diagram for pin out assignments on evaluation board.

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.


[^0]:    [1] Max peak reflow temperature of $260^{\circ} \mathrm{C}$
    [2] 4-Digit lot number XXXX

